

# Model 1190100-XXX

## 20 MHz, Stratum 3E OCXO

### Features

- Industry standard 25.4 x 22 mm SMT package
- Stratum 3E per GR-1244-Core and CR-253-Core
- 3.3V or 5.0V operation
- Low Phase Noise
- Tape and Reel packaging



### Applications

- Telecom Switching
- Wireless Communication
- Timing over Packet

25.4 x 22 x 12 mm

### Description

The CTS model 1190100 is a low cost, small size, high performance OCXO. The high quality CTS Quartz Crystal used in this OCXO offers high stability and low jitter/phase noise, making it the ideal choice for any telecommunications system

### Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
<b>Operating Conditions</b>					
Operating Temperature Range		-40	-	+85	°C
Supply Voltage	3.3V 5.0V	3.135 4.75	3.3 5.0	3.465 5.25	Vdc
Power Consumption	Warm up Steady state @ 25°C	- -	- -	2.5 1.2	W
Load	Output to Ground	5	10	15	pf

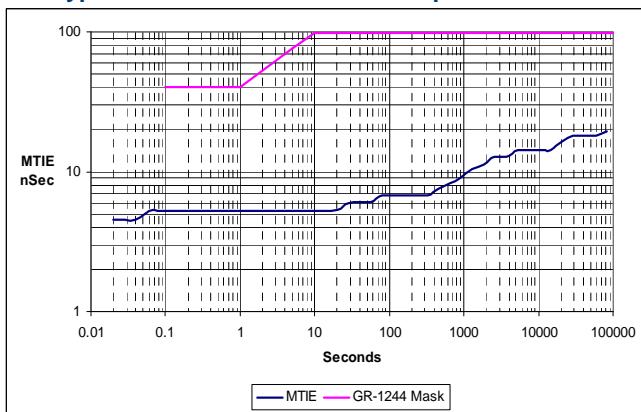
### Frequency Stability

Frequency	$F_{NOM}$	20.000	MHz
Calibration	$\Delta F/F_{NOM}$ ; at time of shipment	$\pm 75$	ppb
Temperature Stability	See options table	7	ppb pk-pk
Voltage Stability	$\pm 5\%$	$\pm 1$	ppb
	Per day, at time of shipment	$\pm 0.5$	ppb/day
Aging	First year	$\pm 100$	ppb
	10 years	$\pm 700$	ppb
Holdover (24 hours)	Inclusive of operating temp and 24 hours aging drift – See Table 1	11	ppb pk-pk

## Electrical Specifications

Parameter	Conditions & Remarks	Min	Typical	Max	Unit
<b>Operating Conditions Continued</b>					
Total Free-Run Accuracy	Under all conditions for 10 years	-	-	$\pm 2.5$	ppm
Drift	24 hours at constant temperature – See Table 1	-	-	$\pm 1$	ppb
	1.0 sec	-	<0.01	0.02	
	10 sec	-	0.01	0.03	
Short Term Stability	100 sec	-	0.02	0.05	ppb
ADEV (in still air)	1000 sec	-	0.05	0.1	
	10,000 sec	-	0.07	0.2	
Wander Generation	MTIE and TDEV per Stratum 3E requirements per GR-1244-CORE and GR-253-CORE				
Warm-Up Time	$T_A = 25^\circ\text{C}$ ; to within 50 ppb of frequency @ 30 minutes	-	-	5	minutes
<b>Output Parameters – HCMOS</b>					
Amplitude	$V_{OL}$	-	-	10% $V_{CC}$	V
	$V_{OH}$	90% $V_{CC}$	-	-	
Rise / Fall Times	10% to 90% @ 10pf load	-	-	8	nsec
Duty Cycle	@ 50% of output signal	45	-	55	%
Spurious		-	-	-70	dBc
Phase Noise	Offset = 10Hz	-	-115	-110	
	100Hz	-	-140	-135	
	1KHz	-	-150	-145	
	10KHz	-	-155	-150	

Typical Wander Generation MTIE performance



Typical Wander Generation TDEV performance

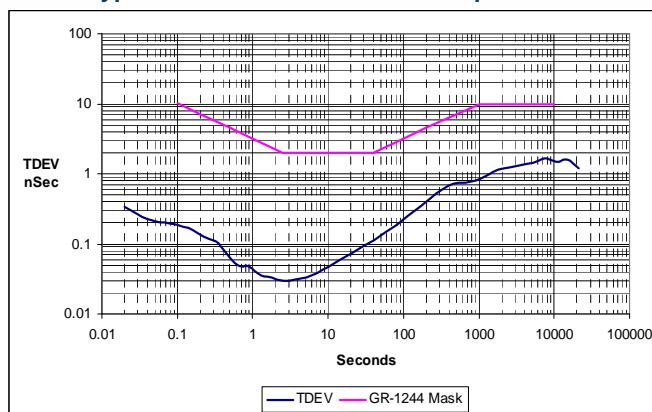


Table 1 – Aging Recovery

Time Off	Minimum power on time to recover daily aging rate
≤ 1 day	24 hours
< 1 week	3 days
< 1 month	6 days

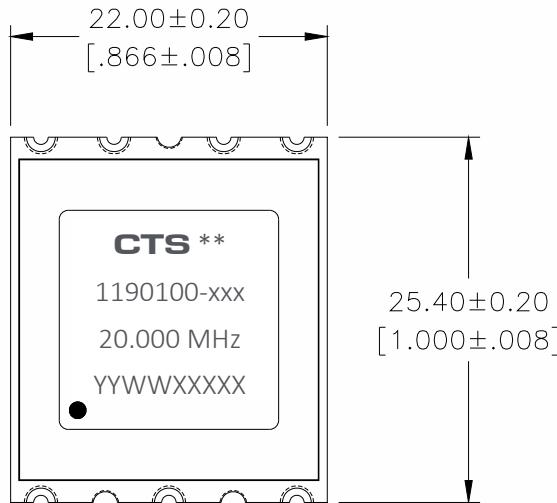
## Options and Part Number

Dash No.	Supply voltage	Operating Temp. Range	Part Number
-001	+5.0 Vdc	-20°C to +70°C	1190100-001
-002	+5.0 Vdc	-40°C to +85°C	1190100-002
-003	+3.3 Vdc	-20°C to +70°C	1190100-003
-004	+3.3 Vdc	-40°C to +85°C	1190100-004

## Mechanical and Environmental

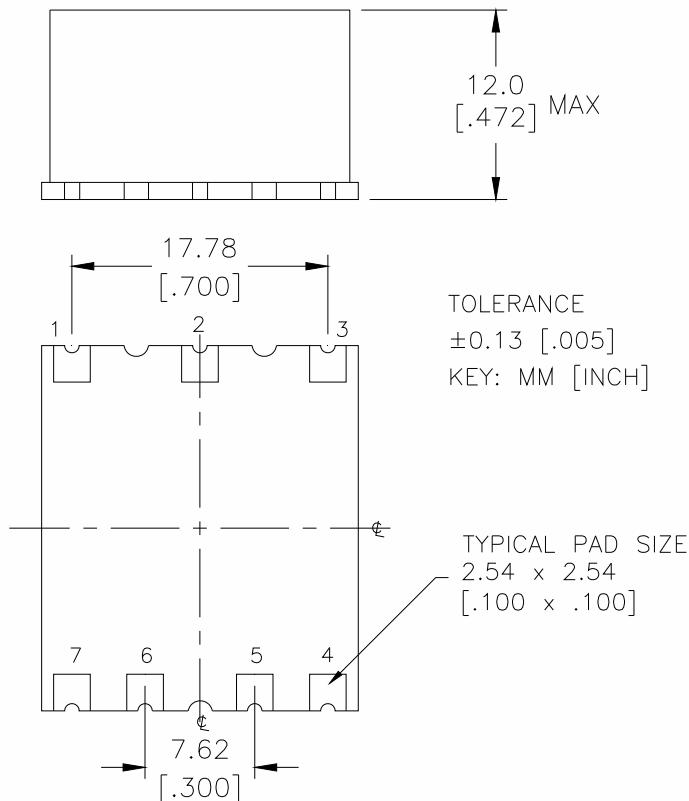
Soldering	Maximum reflow temperature, 245°C for 10 seconds, 240°C for 20 seconds, per IPC/JEDEC J-STD-020C
MSL	Level 1
RoHS	Lead-Free. Fully compliant to RoHS Directive 2011/65/EU
Shock	500 G's, 1msec, 5 shocks in each of 6 directions
Sinusoidal Vibration	10 Hz to 55 Hz with a double amplitude of 1.5 mm, 10 g's peak from 55 Hz to 2000Hz, for 30 minutes in each of three perpendicular directions
Random Vibration	5.35 G's RMS. 20 to 500 Hz, per MIL-STD-202F, Method 214, 15 minutes each axis.
Seal	Non hermetic
Marking Permanency	Per MIL-STD-202F, Method 215J
Attachment Method	SMT
Storage Temp Range	-40 to +85°C

## Mechanical Specifications



PIN 1 IDENTIFIER

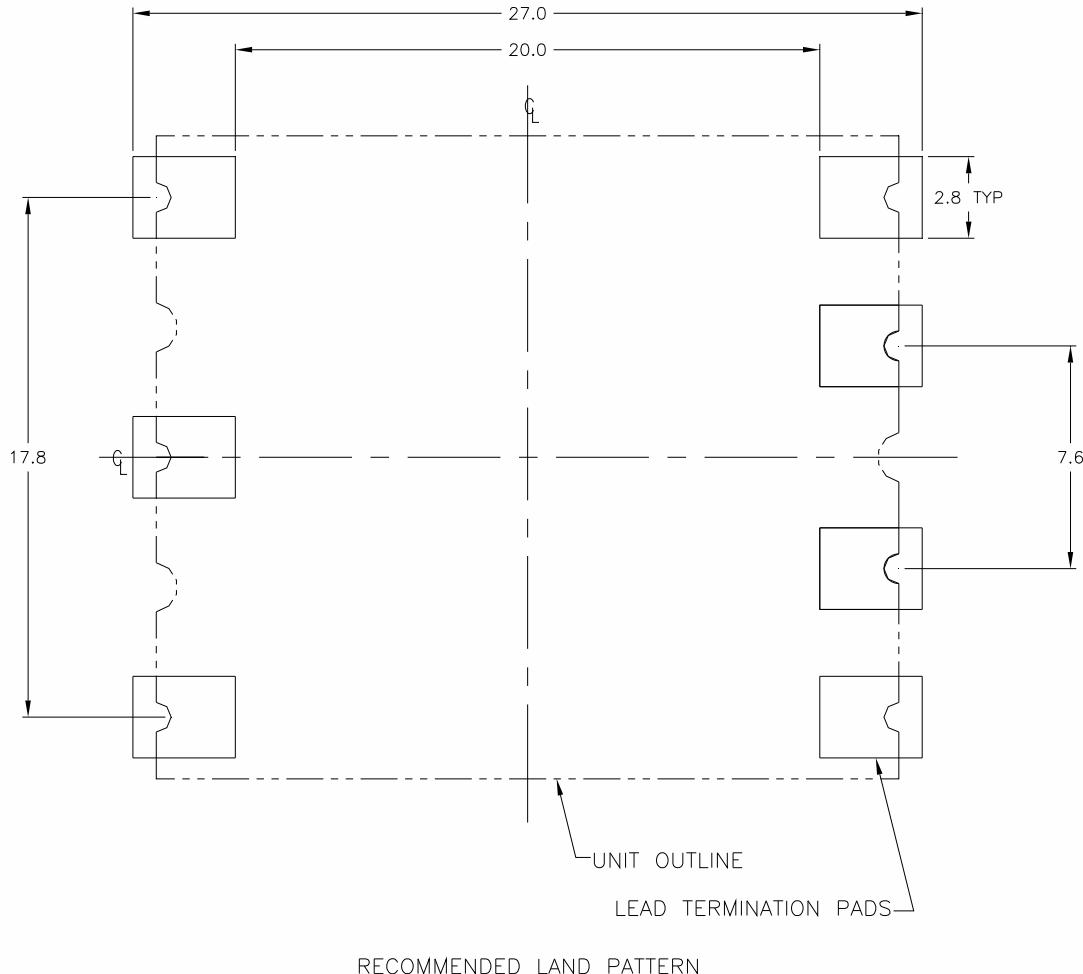
Product Marking	
**	Mfg Site Code
-XXX	P/N option
YYWWXXXXXX	DC/Serial Number



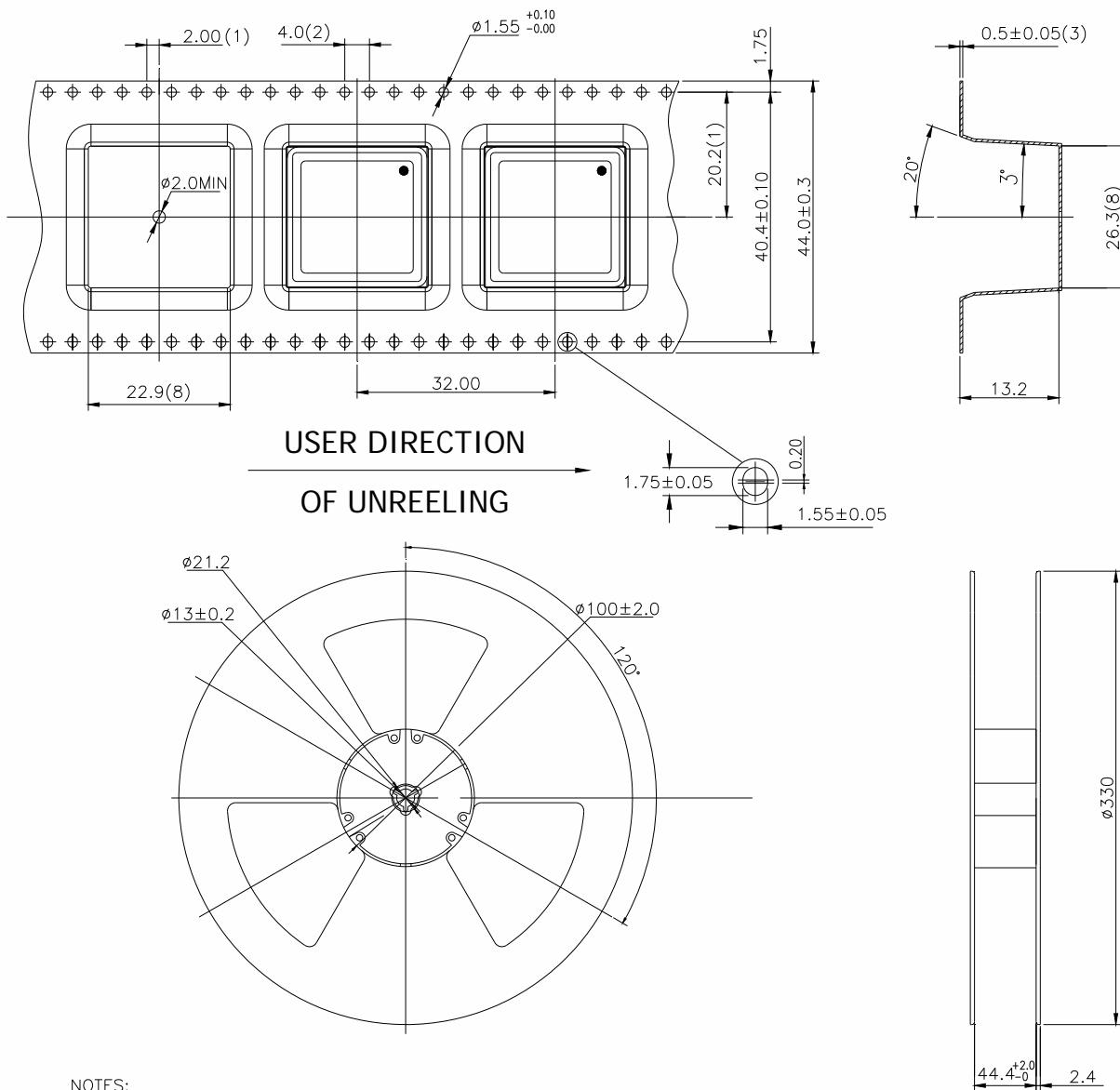
Pin No.	Pin Function
1	NC
2	NC
3	V <sub>CC</sub>
4	Output
5	NC
6	NC
7	Ground

Pad termination finish: Gold Flash &lt;10 micro inch, over Ni plated Cu

## Recommended Land Pattern

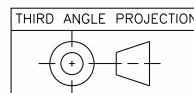


## Packing: Tape and Reel

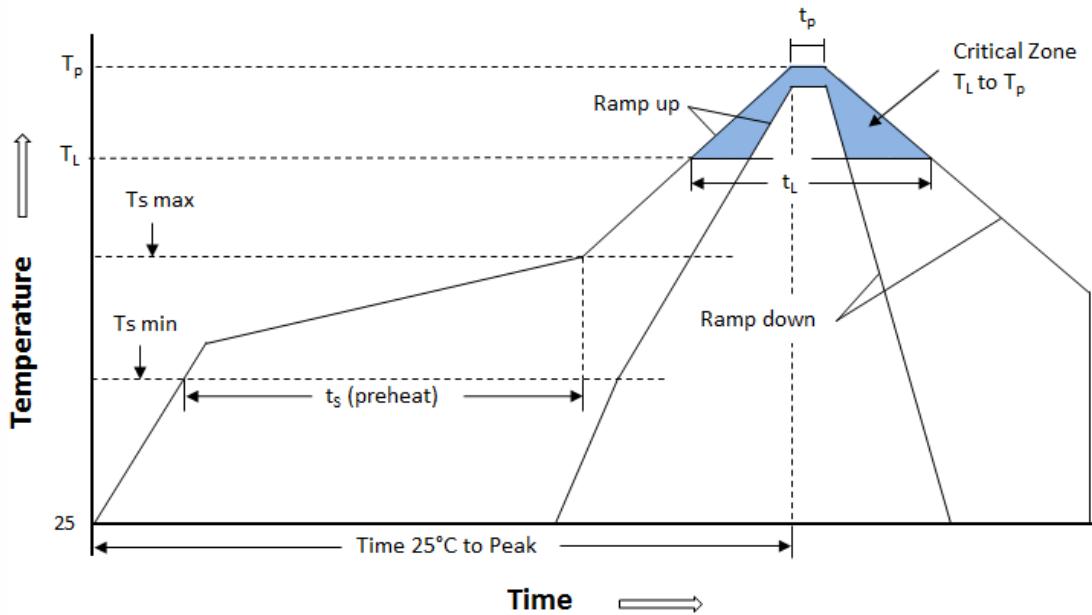


## NOTES:

1. MEASURED FROM THE CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF THE POCKET HOLE AND FROM THE CENTERLINE OF SPROCKET HOLE TO CENTERLINE OF THE POCKET
2. CUMULATIVE TOLERANCE OF 10 SPROCKET HOLES IS  $\pm 0.20$
3. THIS THICKNESS IS APPLICABLE AS MEASURED AT THE EDGE OF THE TAPE
4. MATERIAL:BLACK POLYSTYRENE
5. DIM IN MM
6. ALLOWABLE CAMBER TO BE 1mm PER 100mm IN LENGTH, NON-CUMULATIVE OVER 250mm
7. UNLESS OTHERWISE SPECIFIED, TOLERANCE  $\pm 0.10$
8. MEASUREMENT POINT TO BE 0.3 ABOVE THE INDICATED POINT.
9. SURFACE RESISTIVITY: FROM  $10^5$  TO  $10^1$  OHMS/SQ
10. MAXIMUM QUANTITY 50 UNITS IN ONE TAPE&REEL
11. UNITS: MM



## Reflow profile per IPC/JEDEC J-STD-020C



Note: The temperatures shown below represent the device body temperature

Ts max to $T_L$ (Ramp-up Rate)	3°C/second max
Preheat	
Temperature Min(Ts Min)	150°C
Temperature Typical( Ts Typ)	175°C
Temperature Max.(Ts Max)	200°C
Time( $t_s$ )	60-180 seconds
Ram-up Rate( $T_L$ to $T_p$ )	3°C/second max
Time Maintained Above:	
--Temperature( $T_L$ )	217°C
--Time( $T_L$ )	60-150seconds
Peak Temperature ( $T_p$ )	245°C max for 10 seconds
Time within 5°C of actual peak( $t_p$ )	20 seconds
Ramp-down Rate	6°C/second max
Tune 25°C to Peak Temperature( $t$ )	8 minutes max